



PATENT
0152-0551P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Hideyuki ARIYASU et al Conf.: 7701
Appl. No.: 09/773,627 Group: 1773
Filed: February 2, 2001 Examiner: KRUER
For: THERMOPLASTIC RESIN INTEGRATED
STRUCTURE

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REQUEST FOR RECONSIDERATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 8, 2003

Sir:

In reply to the Office Action dated September 8, 2003, the following Remarks are respectfully submitted in connection with the above-identified application.